

## TMP35/TMP36/TMP37

### FEATURES

- Low voltage operation (2.7 V to 5.5 V)
- Calibrated directly in °C
- 10 mV/°C scale factor (20 mV/°C on TMP37)
- ±2°C accuracy over temperature (typ)
- ±0.5°C linearity (typ)
- Stable with large capacitive loads
- Specified -40°C to +125°C, operation to +150°C
- Less than 50 µA quiescent current
- Shutdown current 0.5 µA max
- Low self-heating

### APPLICATIONS

- Environmental control systems
- Thermal protection
- Industrial process control
- Fire alarms
- Power system monitors
- CPU thermal management

### GENERAL DESCRIPTION

The TMP35, TMP36, and TMP37 are low voltage, precision, centigrade temperature sensors. They provide a voltage output that is linearly proportional to the Celsius (centigrade) temperature. The TMP35/TMP36/TMP37 do not require any external calibration to provide typical accuracies of ±1°C at +25°C and ±2°C over the -40°C to +125°C temperature range.

The low output impedance of the TMP35/TMP36/TMP37 and its linear output and precise calibration simplify interfacing to temperature control circuitry and A/D converters. All three devices are intended for single-supply operation from 2.7 V to 5.5 V maximum. The supply current runs well below 50 µA, providing very low self-heating—less than 0.1°C in still air. In addition, a shutdown function is provided to cut the supply current to less than 0.5 µA.

The TMP35 is functionally compatible with the LM35/LM45 and provides a 250 mV output at 25°C. The TMP35 reads temperatures from 10°C to 125°C. The TMP36 is specified from -40°C to +125°C, provides a 750 mV output at 25°C, and operates to 125°C from a single 2.7 V supply. The TMP36 is functionally compatible with the LM50. Both the TMP35 and TMP36 have an output scale factor of 10 mV/°C. The TMP37 is intended for applications over the range 5°C to 100°C and

provides an output scale factor of 20 mV/°C. The TMP37 provides a 500 mV output at 25°C. Operation extends to 150°C with reduced accuracy for all devices when operating from a 5 V supply.

The TMP35/TMP36/TMP37 are available in low cost 3-lead TO-92, SOIC-8, and 5-lead SOT-23 surface-mount packages.

### FUNCTIONAL BLOCK DIAGRAM

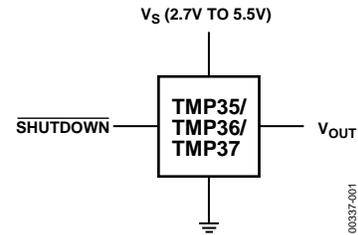


Figure 1.

### PIN CONFIGURATIONS

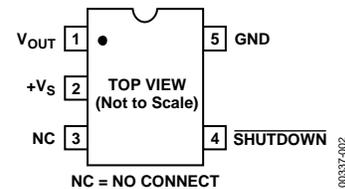


Figure 2. RT-5 (SOT-23)

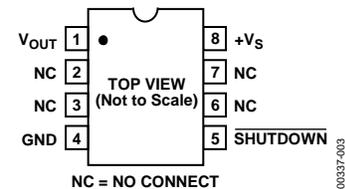
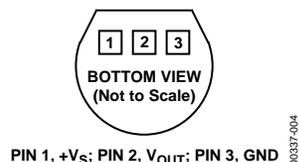


Figure 3. RN-8 (SOIC)



PIN 1, +V<sub>S</sub>; PIN 2, V<sub>OUT</sub>; PIN 3, GND

Figure 4. TO-92

### Rev. D

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## TABLE OF CONTENTS

Specifications.....	3	Microprocessor Interrupt Generator.....	13
Absolute Maximum Ratings.....	4	Thermocouple Signal Conditioning with Cold-Junction Compensation.....	14
ESD Caution.....	4	Using TMP3x Sensors in Remote Locations .....	15
Typical Performance Characteristics .....	5	Temperature to 4–20 mA Loop Transmitter .....	15
Functional Description .....	8	Temperature to Frequency Converter .....	16
Applications.....	9	Driving Long Cables or Heavy Capacitive Loads .....	17
Shutdown Operation.....	9	Commentary on Long-Term Stability .....	17
Mounting Considerations .....	9	Outline Dimensions .....	18
Thermal Environment Effects .....	9	Ordering Guide .....	19
Basic Temperature Sensor Connections.....	10		
Fahrenheit Thermometers .....	10		
Average and Differential Temperature Measurement .....	12		

## REVISION HISTORY

### 3/05—Rev. C to Rev. D

Updated Format.....	Universal
Changes to Specifications.....	3
Additions to Absolute Maximum Ratings.....	4
Updated Outline Dimensions .....	19
Changes to Ordering Guide .....	19

### 10/02—Rev. B to Rev. C

Deleted text from Commentary on Long-Term Stability section .....	13
Update OUTLINE DIMENSIONS.....	14

### 9/01—Rev. A to Rev. B

## SPECIFICATIONS

$V_S = 2.7\text{ V to }5.5\text{ V}$ ,  $-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$ , unless otherwise noted.

Table 1.

Parameter <sup>1</sup>	Symbol	Conditions	Min	Typ	Max	Unit
<b>ACCURACY</b>						
TMP35/TMP36/TMP37F		$T_A = 25^\circ\text{C}$		$\pm 1$	$\pm 2$	$^\circ\text{C}$
TMP35/TMP36/TMP37G		$T_A = 25^\circ\text{C}$		$\pm 1$	$\pm 3$	$^\circ\text{C}$
TMP35/TMP36/TMP37F		Over rated temperature		$\pm 2$	$\pm 3$	$^\circ\text{C}$
TMP35/TMP36/TMP37G		Over rated temperature		$\pm 2$	$\pm 4$	$^\circ\text{C}$
Scale Factor, TMP35		$10^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$		10		mV/ $^\circ\text{C}$
Scale Factor, TMP36		$-40^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$		10		mV/ $^\circ\text{C}$
Scale Factor, TMP37		$5^\circ\text{C} \leq T_A \leq 85^\circ\text{C}$		20		mV/ $^\circ\text{C}$
		$5^\circ\text{C} \leq T_A \leq 100^\circ\text{C}$		20		mV/ $^\circ\text{C}$
Load Regulation		$3.0\text{ V} \leq V_S \leq 5.5\text{ V}$				
		$0\ \mu\text{A} \leq I_L \leq 50\ \mu\text{A}$				
		$-40^\circ\text{C} \leq T_A \leq +105^\circ\text{C}$		6	20	m $^\circ\text{C}/\mu\text{A}$
		$-105^\circ\text{C} \leq T_A \leq +125^\circ\text{C}$		25	60	m $^\circ\text{C}/\mu\text{A}$
Power Supply Rejection Ratio	PSRR	$T_A = 25^\circ\text{C}$		30	100	m $^\circ\text{C}/\text{V}$
		$3.0\text{ V} \leq V_S \leq 5.5\text{ V}$		50		m $^\circ\text{C}/\text{V}$
Linearity				0.5		$^\circ\text{C}$
Long-Term Stability		$T_A = 150^\circ\text{C}$ for 1 kHz		0.4		$^\circ\text{C}$
<b>SHUTDOWN</b>						
Logic High Input Voltage	$V_{IH}$	$V_S = 2.7\text{ V}$	1.8			V
Logic Low Input Voltage	$V_{IL}$	$V_S = 5.5\text{ V}$			400	mV
<b>OUTPUT</b>						
TMP35 Output Voltage		$T_A = 25^\circ\text{C}$		250		mV
TMP36 Output Voltage		$T_A = 25^\circ\text{C}$		750		mV
TMP37 Output Voltage		$T_A = 25^\circ\text{C}$		500		mV
Output Voltage Range			100		2000	mV
Output Load Current	$I_L$		0		50	$\mu\text{A}$
Short-Circuit Current	$I_{SC}$	Note 2			250	$\mu\text{A}$
Capacitive Load Driving	$C_L$	No oscillations <sup>2</sup>	1000	10000		pF
Device Turn-On Time		Output within $\pm 1^\circ\text{C}$ 100 k $\Omega$   100 pF load		0.5	1	ms
<b>POWER SUPPLY</b>						
Supply Range	$V_S$		2.7		5.5	V
Supply Current	$I_{SY}$ (ON)	Unloaded			50	$\mu\text{A}$
Supply Current (Shutdown)	$I_{SY}$ (OFF)	Unloaded		0.01	0.5	$\mu\text{A}$

<sup>1</sup> Does not consider errors caused by self-heating.

<sup>2</sup> Guaranteed but not tested.

# TMP35/TMP36/TMP37

## ABSOLUTE MAXIMUM RATINGS

Table 2.

Parameter <sup>1,2</sup>	Rating
Supply Voltage	7 V
Shutdown Pin	$GND \leq \overline{SHUTDOWN} \leq V_S$
Output Pin	$GND \leq V_{OUT} \leq V_S$
Operating Temperature Range	-55°C to +150°C
Die Junction Temperature	175°C
Storage Temperature Range	-65°C to +160°C
IR Reflow Soldering	
Peak Temperature	220°C (0°C/5°C)
Time at Peak Temperature	10 s to 20 s
Ramp-up Rate	3°C/s max
Ramp-down Rate	-6°C/s max
Time 25°C to Peak Temperature	6 mins max
IR Reflow Soldering—Pb-free Package	
Peak Temperature	260°C (0°C)
Time at Peak Temperature	20 s to 40 s
Ramp-up Rate	3°C/s max
Ramp-down Rate	-6°C/s max
Time 25°C to Peak Temperature	8 min max

<sup>1</sup> Digital inputs are protected; however, permanent damage might occur on unprotected units from high energy electrostatic fields. Keep units in conductive foam or packaging at all times until ready to use. Use proper antistatic handling procedures.

<sup>2</sup> Remove power before inserting or removing units from their sockets.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Type	$\theta_{JA}$ <sup>1</sup>	$\theta_{JC}$	Unit
TO-92 (T9 Suffix)	162	120	°C/W
SOIC-8 (S Suffix)	158	43	°C/W
SOT-23 (RT Suffix)	300	180	°C/W

<sup>1</sup>  $\theta_{JA}$  is specified for device in socket (worst-case conditions).

### ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



# TYPICAL PERFORMANCE CHARACTERISTICS

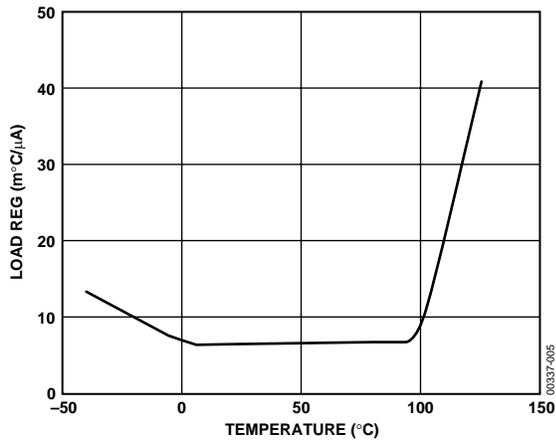


Figure 5. Load Regulation vs. Temperature ( $m^{\circ}C/\mu A$ )

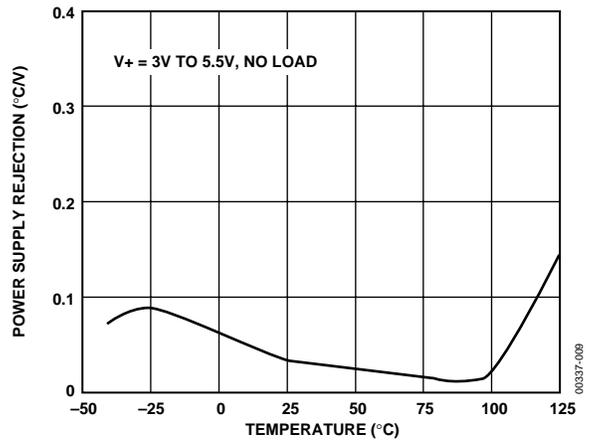


Figure 8. Power Supply Rejection vs. Temperature

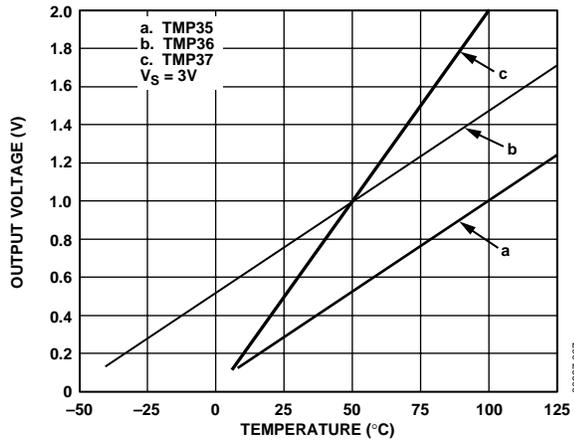


Figure 6. Output Voltage vs. Temperature

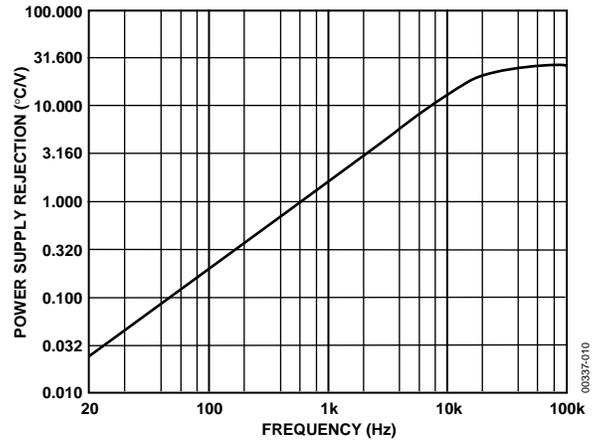


Figure 9. Power Supply Rejection vs. Frequency

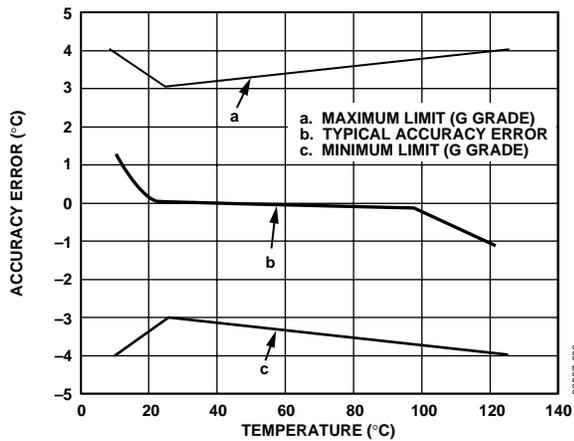


Figure 7. Accuracy Error vs. Temperature

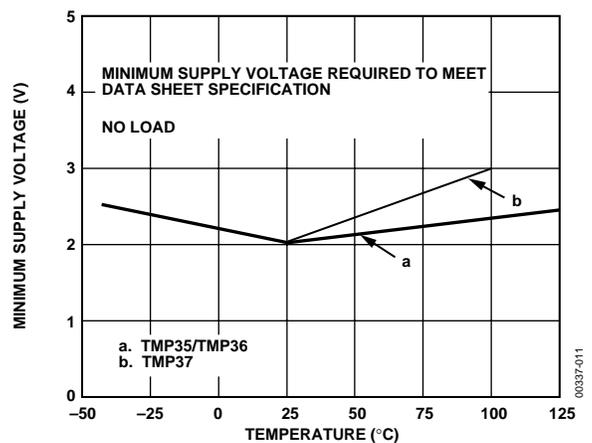


Figure 10. Minimum Supply Voltage vs. Temperature

# TMP35/TMP36/TMP37

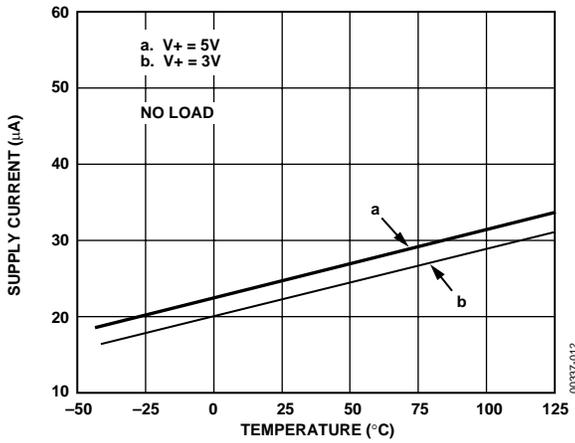


Figure 11. Supply Current vs. Temperature

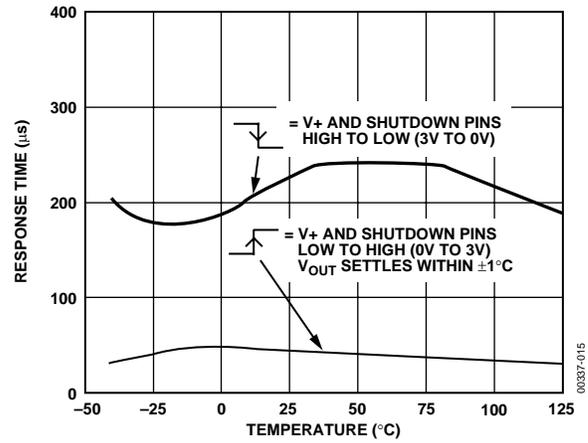


Figure 14.  $V_{OUT}$  Response Time for  $V+$  Power-Up/Power-Down vs. Temperature

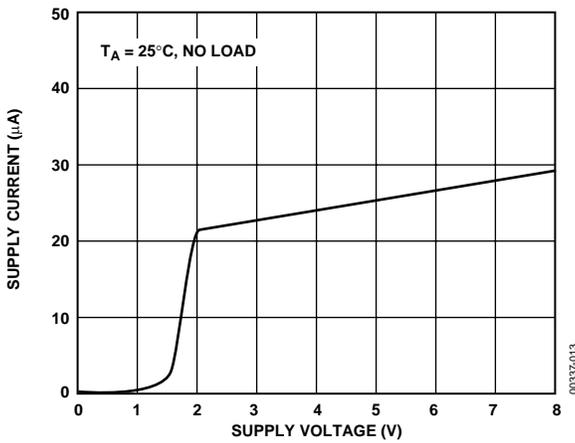


Figure 12. Supply Current vs. Supply Voltage

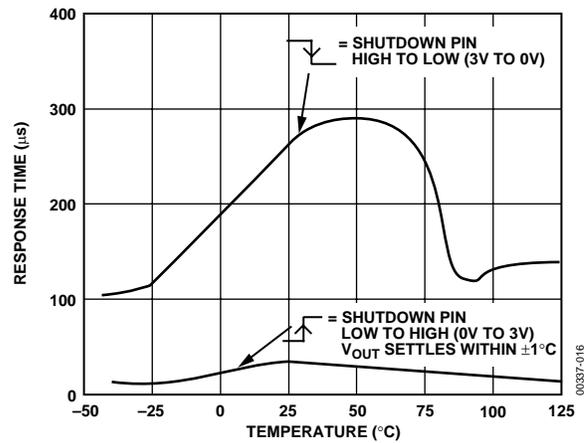


Figure 15.  $V_{OUT}$  Response Time for Shutdown Pin vs. Temperature

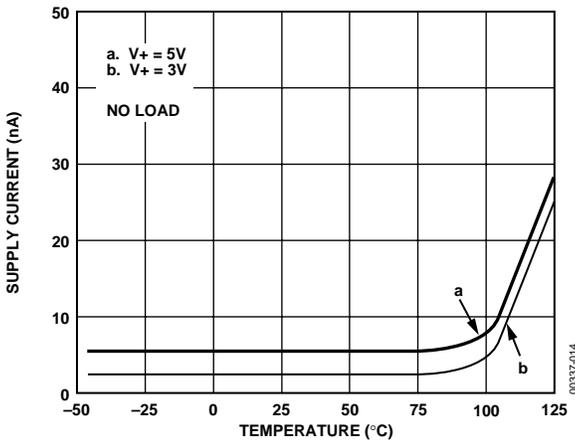


Figure 13. Supply Current vs. Temperature (Shutdown = 0 V)

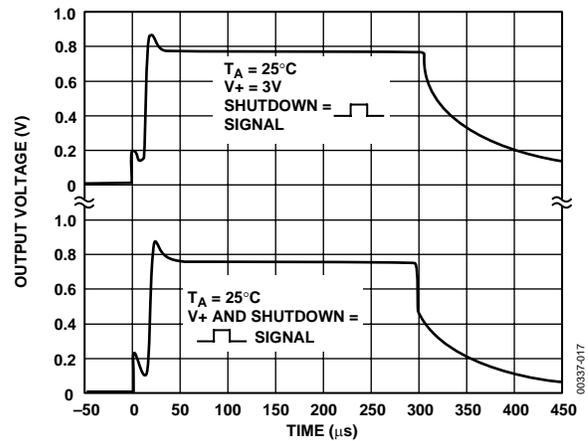


Figure 16.  $V_{OUT}$  Response Time to Shutdown and  $V+$  Pins vs. Time

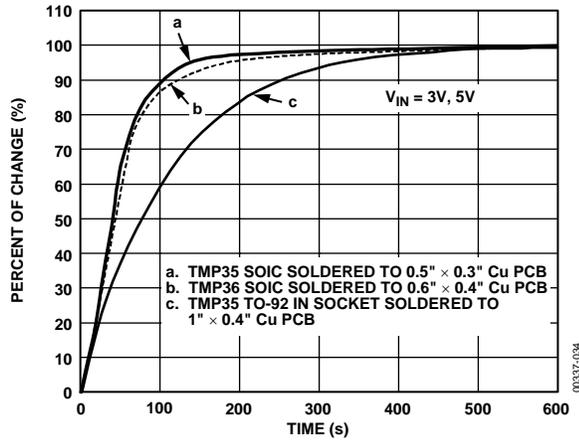


Figure 17. Thermal Response Time in Still Air

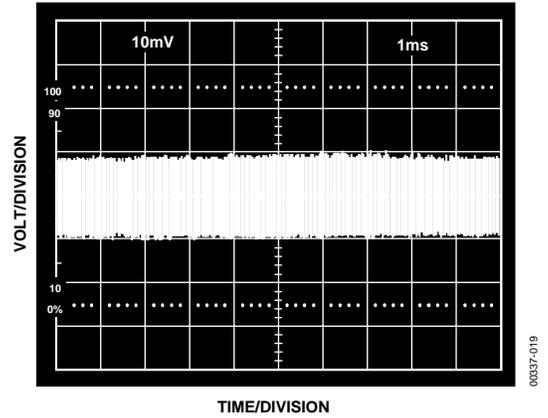


Figure 20. Temperature Sensor Wideband Output Noise Voltage; Gain = 100, BW = 157 kHz

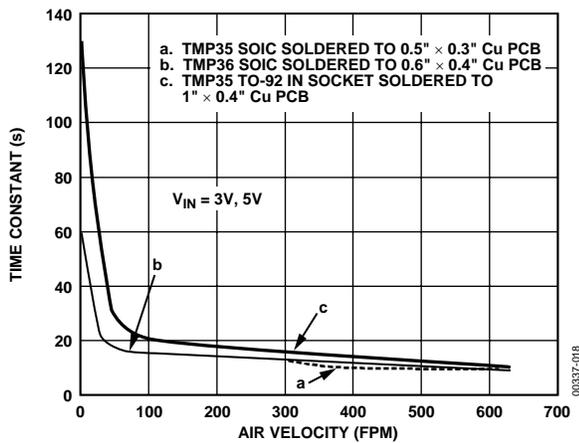


Figure 18. Thermal Response Time Constant in Forced Air

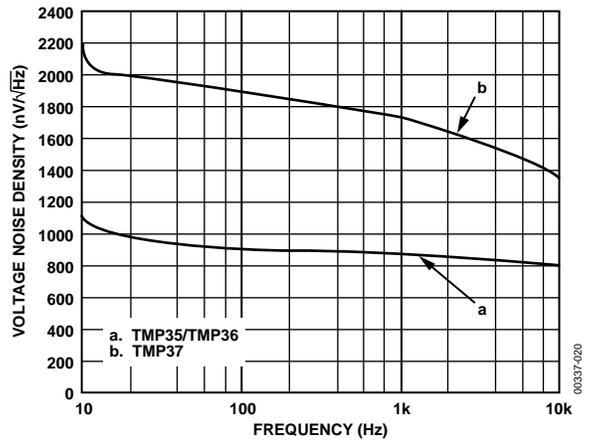


Figure 21. Voltage Noise Spectral Density vs. Frequency

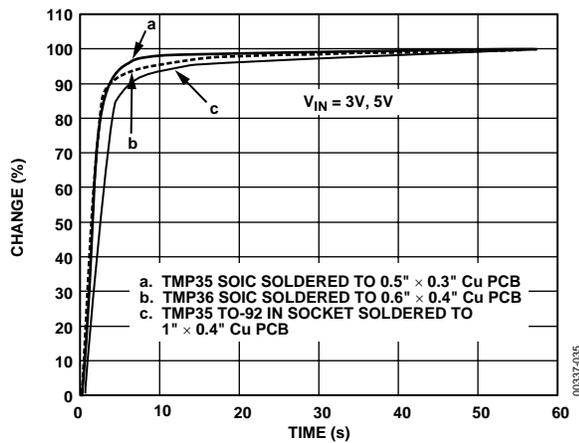


Figure 19. Thermal Response Time in Stirred Oil Bath



## APPLICATIONS

### SHUTDOWN OPERATION

All TMP3x devices include a shutdown capability, which reduces the power supply drain to less than 0.5  $\mu$ A maximum. This feature, available only in the SOIC-8 and the SOT-23 packages, is TTL/CMOS level-compatible, provided that the temperature sensor supply voltage is equal in magnitude to the logic supply voltage. Internal to the TMP3x at the SHUTDOWN pin, a pull-up current source to  $V_{IN}$  is connected. This permits the SHUTDOWN pin to be driven from an open-collector/drain driver. A logic low, or zero-volt condition on the SHUTDOWN pin is required to turn off the output stage. During shutdown, the output of the temperature sensors becomes a high impedance state where the potential of the output pin would then be determined by external circuitry. If the shutdown feature is not used, it is recommended that the SHUTDOWN pin be connected to  $V_{IN}$  (Pin 8 on the SOIC-8; Pin 2 on the SOT-23).

The shutdown response time of these temperature sensors is shown in Figure 14, Figure 15, and Figure 16.

### MOUNTING CONSIDERATIONS

If the TMP3x temperature sensors are thermally attached and protected; they can be used in any temperature measurement application where the maximum temperature range of the medium is between  $-40^{\circ}\text{C}$  and  $+125^{\circ}\text{C}$ . Properly cemented or glued to the surface of the medium, these sensors are within  $0.01^{\circ}\text{C}$  of the surface temperature. Caution should be exercised, especially with TO-92 packages, because the leads and any wiring to the device can act as heat pipes, introducing errors if the surrounding air-surface interface is not isothermal. Avoiding this condition is easily achieved by dabbing the leads of the temperature sensor and the hookup wires with a bead of thermally conductive epoxy. This ensures that the TMP3x die temperature is not affected by the surrounding air temperature. Because plastic IC packaging technology is used, excessive mechanical stress should be avoided when fastening the device with a clamp or a screw-on heat tab. Thermally conductive epoxy or glue, which must be electrically nonconductive, is recommended under typical mounting conditions.

These temperature sensors, as well as any associated circuitry, should be kept insulated and dry to avoid leakage and corrosion. In wet or corrosive environments, any electrically isolated metal or ceramic well can be used to shield the temperature sensors. Condensation at very cold temperatures can cause errors and should be avoided by sealing the device, using electrically nonconductive epoxy paints or dip or any one of the many printed circuit board coatings and varnishes.

### THERMAL ENVIRONMENT EFFECTS

The thermal environment in which the TMP3x sensors are used determines two important characteristics: self-heating effects and thermal response time. Figure 23 illustrates a thermal model of the TMP3x temperature sensors, which is useful in understanding these characteristics.

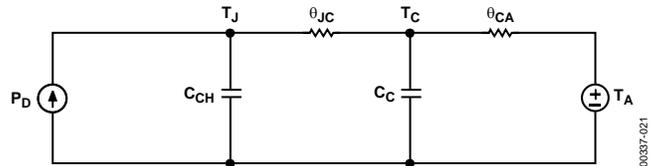


Figure 23. Thermal Circuit Model

In the TO-92 package, the thermal resistance junction-to-case,  $\theta_{JC}$ , is  $120^{\circ}\text{C}/\text{W}$ . The thermal resistance case-to-ambient,  $C_A$ , is the difference between  $\theta_{JA}$  and  $\theta_{JC}$ , and is determined by the characteristics of the thermal connection. The temperature sensor's power dissipation,  $P_D$ , is the product of the total voltage across the device and its total supply current, including any current delivered to the load. The rise in die temperature above the medium's ambient temperature is given by

$$T_J = P_D \times (\theta_{JC} + \theta_{CA}) + T_A$$

Thus, the die temperature rise of a TMP35 SOT-23 package mounted into a socket in still air at  $25^{\circ}\text{C}$  and driven from a 5 V supply is less than  $0.04^{\circ}\text{C}$ .

The transient response of the TMP3x sensors to a step change in the temperature is determined by the thermal resistances and the thermal capacities of the die,  $C_{CH}$ , and the case,  $C_C$ . The thermal capacity  $C_C$  varies with the measurement medium since it includes anything in direct contact with the package. In all practical cases, the thermal capacity of  $C_C$  is the limiting factor in the thermal response time of the sensor and can be represented by a single-pole RC time constant response. Figure 17 and Figure 19 show the thermal response time of the TMP3x sensors under various conditions. The thermal time constant of a temperature sensor is defined as the time required for the sensor to reach 63.2% of the final value for a step change in the temperature. For example, the thermal time constant of a TMP35 SOIC package sensor mounted onto a 0.5" by 0.3" PCB is less than 50 sec in air, whereas in a stirred oil bath, the time constant is less than 3 sec.

# TMP35/TMP36/TMP37

## BASIC TEMPERATURE SENSOR CONNECTIONS

Figure 24 illustrates the basic circuit configuration for the TMP3x family of temperature sensors. The table in Figure 24 shows the pin assignments of the temperature sensors for the three package types. For the SOT-23, Pin 3 is labeled as NC, as are Pins 2, 3, 6, and 7 on the SOIC-8 package. It is recommended that no electrical connections be made to these pins. If the shutdown feature is not needed on the SOT-23 or the SOIC-8 package, the SHUTDOWN pin should be connected to  $V_S$ .

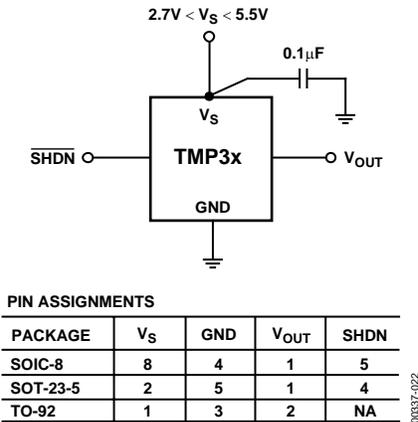


Figure 24. Basic Temperature Sensor Circuit Configuration

Note the 0.1  $\mu\text{F}$  bypass capacitor on the input. This capacitor should be a ceramic type, have very short leads (surface-mount is preferable), and be located as close as possible in physical proximity to the temperature sensor supply pin. Since these temperature sensors operate on very little supply current and could be exposed to very hostile electrical environments, it is important to minimize the effects of radio frequency interference (RFI) on these devices. The effect of RFI on these temperature sensors in specific and analog ICs in general is manifested as abnormal dc shifts in the output voltage due to the rectification of the high frequency ambient noise by the IC. When the devices are operated in the presence of high frequency radiated or conducted noise, a large value tantalum capacitor ( $\pm 2.2 \mu\text{F}$ ) placed across the 0.1  $\mu\text{F}$  ceramic might offer additional noise immunity.

## FAHRENHEIT THERMOMETERS

Although the TMP3x temperature sensors are centigrade temperature sensors, a few components can be used to convert the output voltage and transfer characteristics to directly read Fahrenheit temperatures. Figure 25 shows an example of a simple Fahrenheit thermometer using either the TMP35 or the TMP37. This circuit can be used to sense temperatures from 41°F to 257°F with an output transfer characteristic of 1 mV/°F using the TMP35, and from 41°F to 212°F using the TMP37 with an output characteristic of 2 mV/°F. This particular approach does not lend itself to the TMP36 because of its inherent 0.5 V output offset. The circuit is constructed with an AD589, a 1.23 V voltage reference, and four resistors whose values for each sensor are shown in the table in Figure 25. The scaling of the output resistance levels is to ensure minimum output loading on the temperature sensors. A generalized expression for the circuit's transfer equation is given by

$$V_{OUT} = \left( \frac{R1}{R1 + R2} \right) (TMP35) + \left( \frac{R3}{R3 + R4} \right) (AD589)$$

where:

$TMP35$  is the output voltage of the TMP35 or the TMP37 at the measurement temperature,  $T_M$ .

$AD589$  is the output voltage of the reference = 1.23 V.

The output voltage of this circuit is not referenced to the circuit's common ground. If this output voltage were applied directly to the input of an ADC, the ADC's common ground should be adjusted accordingly.

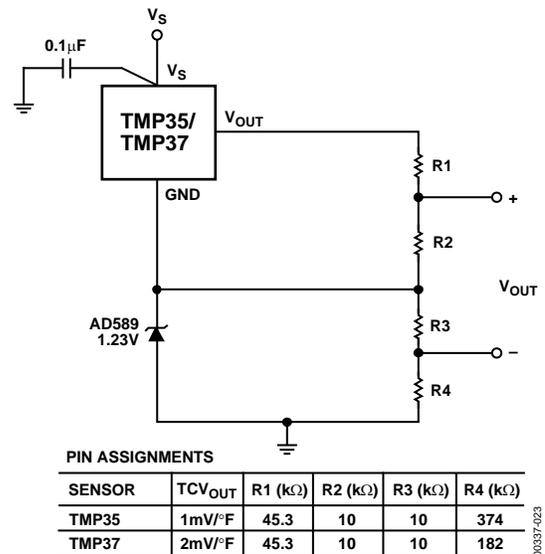


Figure 25. TMP35/TMP37 Fahrenheit Thermometers

The same circuit principles can be applied to the TMP36, but because of the TMP36's inherent offset, the circuit uses two less resistors as shown in Figure 26. In this circuit, the output voltage transfer characteristic is 1 mV/°F but is referenced to the circuit's common ground; however, there is a 58 mV (58°F) offset in the output voltage. For example, the output voltage of the circuit would read 18 mV were the TMP36 placed in -40°F ambient environment and 315 mV at 257°F.

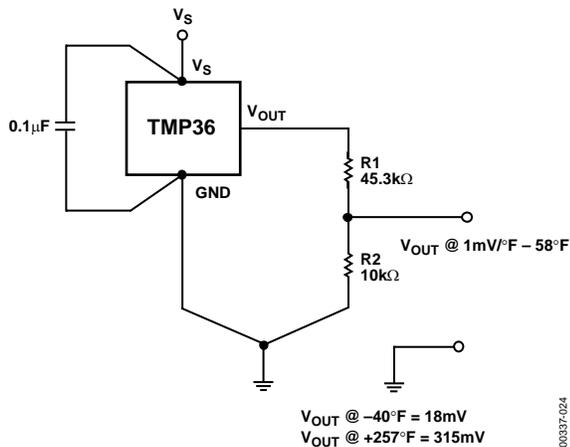


Figure 26. TMP36 Fahrenheit Thermometer Version 1

At the expense of additional circuitry, the offset produced by the circuit in Figure 26 can be avoided by using the circuit in Figure 27. In this circuit, the output of the TMP36 is conditioned by a single supply, micropower op amp, the OP193. Although the entire circuit operates from a single 3 V supply, the output voltage of the circuit reads the temperature directly, with a transfer characteristic of 1 mV/°F, without offset. This is accomplished through an ADM660, which is a supply voltage inverter. The 3 V supply is inverted and applied to the P193's V-terminal. Thus, for a temperature range between -40°F and +257°F, the output of the circuit reads -40 mV to +257 mV. A general expression for the circuit's transfer equation is given by

$$V_{OUT} = \left( \frac{R6}{R5 + R6} \right) \left( 1 + \frac{R4}{R3} \right) (TMP36) - \left( \frac{R4}{R3} \right) \left( \frac{V_S}{2} \right)$$

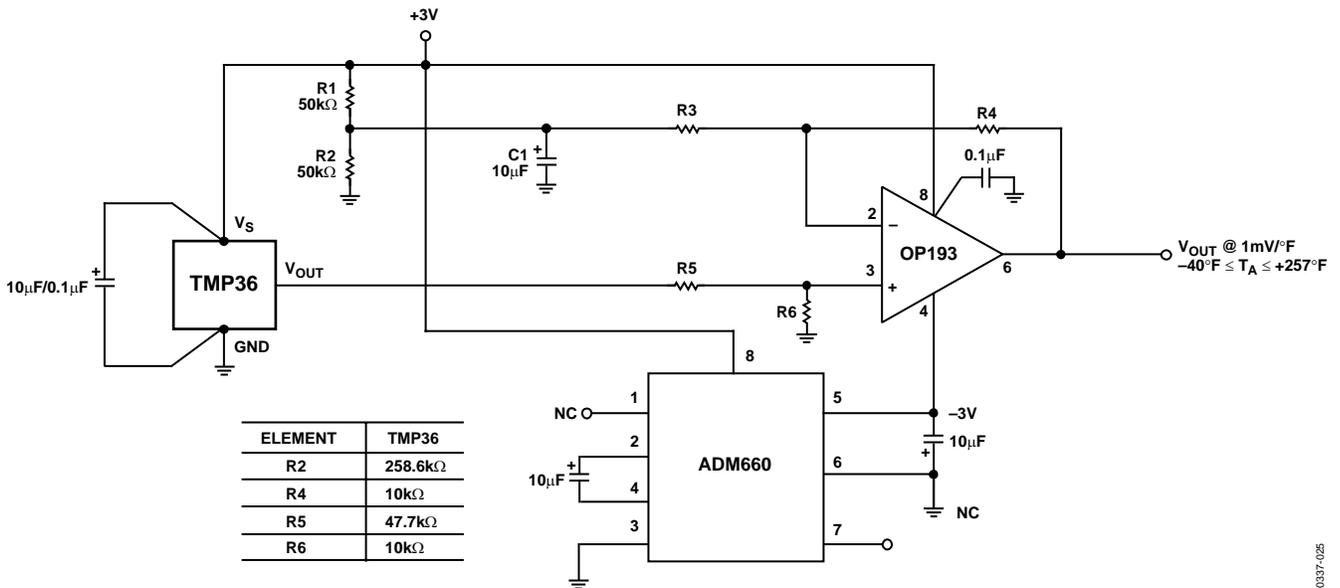


Figure 27. TMP36 Fahrenheit Thermometer Version 2

# TMP35/TMP36/TMP37

## AVERAGE AND DIFFERENTIAL TEMPERATURE MEASUREMENT

In many commercial and industrial environments, temperature sensors often measure the average temperature in a building, or the difference in temperature between two locations on a factory floor or in an industrial process. The circuits in Figure 28 and Figure 29 demonstrate an inexpensive approach to average and differential temperature measurement. In Figure 28, an OP193 sums the outputs of three temperature sensors to produce an output voltage scaled by 10 mV/°C that represents the average temperature at three locations. The circuit can be extended to as many temperature sensors as required as long as the circuit's transfer equation is maintained. In this application, it is recommended that one temperature sensor type be used throughout the circuit; otherwise, the output voltage of the circuit cannot produce an accurate reading of the various ambient conditions.

The circuit in Figure 29 illustrates how a pair of TMP3x sensors used with an OP193 configured as a difference amplifier can read the difference in temperature between two locations. In these applications, it is always possible that one temperature sensor is reading a temperature below that of the other sensor. To accommodate this condition, the output of the OP193 is offset to a voltage at one-half the supply via R5 and R6. Thus, the output voltage of the circuit is measured relative to this point, as shown in the figure. Using the TMP36, the output voltage of the circuit is scaled by 10 mV/°C. To minimize the error in the difference between the two measured temperatures, a common, readily available thin-film resistor network is used for R1 to R4.

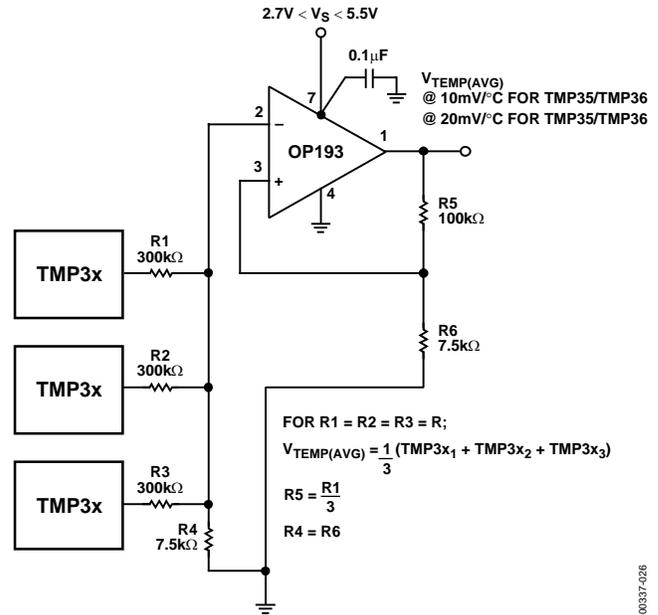
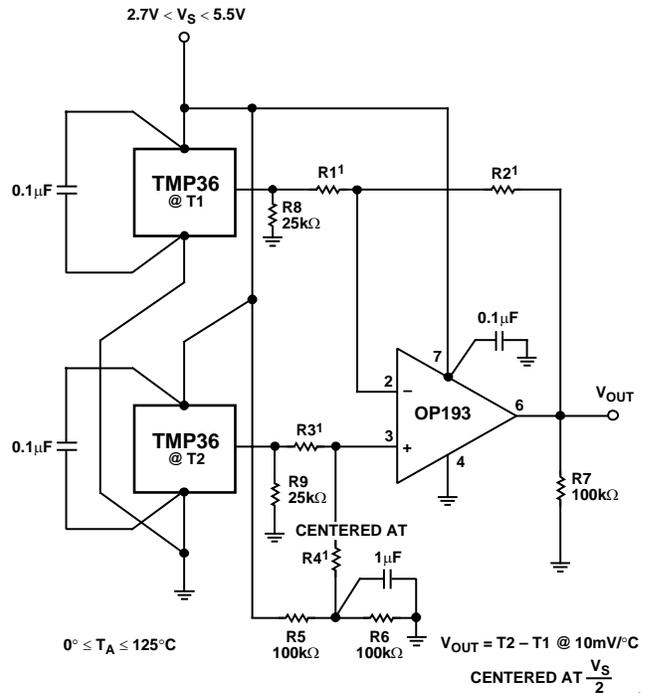


Figure 28. Configuring Multiple Sensors for Average Temperature Measurements



NOTE:  
<sup>1</sup> R1–R4, Caddock T914–100k–100, OR EQUIVALENT.

Figure 29. Configuring Multiple Sensors for Differential Temperature Measurements

## MICROPROCESSOR INTERRUPT GENERATOR

These inexpensive temperature sensors can be used with a voltage reference and an analog comparator to configure an interrupt generator for microprocessor applications. With the popularity of fast 486 and Pentium® laptop computers, the need to indicate a microprocessor overtemperature condition has grown tremendously. The circuit in Figure 30 demonstrates one way to generate an interrupt using a TMP35, a CMP402 analog comparator, and a REF191, a 2 V precision voltage reference.

The circuit is designed to produce a logic high interrupt signal if the microprocessor temperature exceeds 80°C. This 80°C trip point was arbitrarily chosen (final value set by the microprocessor thermal reference design) and is set using an R3–R4 voltage divider of the REF191's output voltage. Since the output of the TMP35 is scaled by 10 mV/°C, the voltage at the CMP402's inverting terminal is set to 0.8 V.

Since temperature is a slowly moving quantity, the possibility for comparator chatter exists. To avoid this condition, hysteresis is used around the comparator. In this application, a hysteresis of 5°C about the trip point was arbitrarily chosen; the ultimate value for hysteresis should be determined by the end application. The output logic voltage swing of the comparator with R1 and R2 determine the amount of comparator hysteresis. Using a 3.3 V supply, the output logic voltage swing of the CMP402 is 2.6 V; therefore, for a hysteresis of 5°C (50 mV @ 10 mV/°C), R1 is set to 20 kΩ, and R2 is set to 1 MΩ. An expression for this circuit's hysteresis is given by

$$V_{HYS} = \left( \frac{R1}{R2} \right) (V_{LOGIC SWING, CMP402})$$

Because this circuit is probably used in close proximity to high speed digital circuits, R1 is split into equal values and a 1000 pF is used to form a low-pass filter on the output of the TMP35. Furthermore, to prevent high frequency noise from contaminating the comparator trip point, a 0.1 μF capacitor is used across R4.

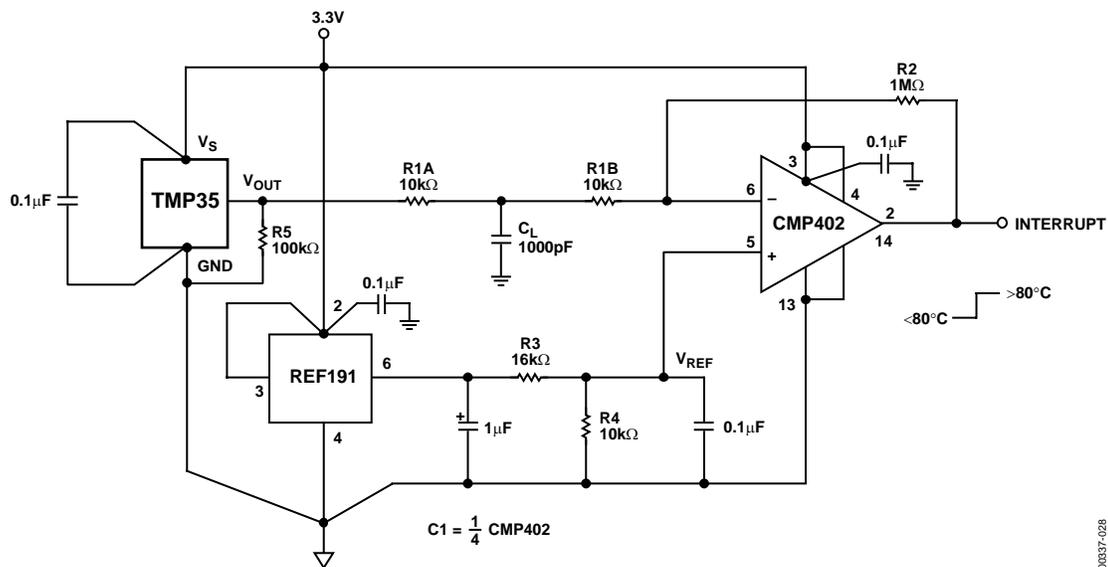


Figure 30. Pentium Overtemperature Interrupt Generator

0037-028



## USING TMP3x SENSORS IN REMOTE LOCATIONS

In many industrial environments, sensors are required to operate in the presence of high ambient noise. These noise sources take on many forms, for example, SCR transients, relays, radio transmitters, arc welders, and ac motors. They can also be used at considerable distances from the signal conditioning circuitry. These high noise environments are very typically in the form of electric fields, so the voltage output of the temperature sensor can be susceptible to contamination from these noise sources.

Figure 32 illustrates a way to convert the output voltage of a TMP3x sensor into a current to be transmitted down a long twisted-pair shielded cable to a ground referenced receiver. The temperature sensors are not capable of high output current operation; thus, a standard PNP transistor is used to boost the output current drive of the circuit. As shown in the table in Figure 32, the values of R2 and R3 were chosen to produce an arbitrary full-scale output current of 2 mA. Lower values for the full-scale current are not recommended. The minimum-scale output current produced by the circuit could be contaminated by nearby ambient magnetic fields operating in the vicinity of the circuit/cable pair. Because the circuit uses an external transistor, the minimum recommended operating voltage for this circuit is 5 V. To minimize the effects of EMI (or RFI), both the circuit and the temperature sensor supply pins are bypassed with good quality, ceramic capacitors.

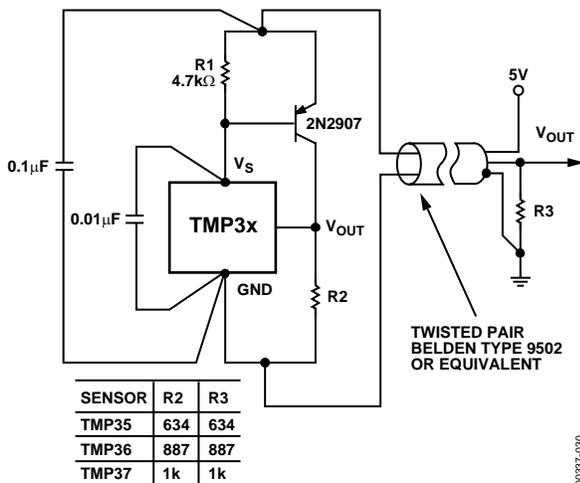


Figure 32. Remote, 2-Wire Boosted Output Current Temperature Sensor

## TEMPERATURE TO 4–20 mA LOOP TRANSMITTER

In many process control applications, 2-wire transmitters are used to convey analog signals through noisy ambient environments. These current transmitters use a zero-scale signal current of 4 mA, which can be used to power the transmitter's signal conditioning circuitry. The full-scale output signal in these transmitters is 20 mA.

Figure 33 illustrates a circuit that transmits temperature information in this fashion. Using a TMP3x as the temperature sensor, the output current is linearly proportional to the temperature of the medium. The entire circuit operates from the 3 V output of the REF193. The REF193 requires no external trimming because of the REF193's tight initial output voltage tolerance and the low supply current of TMP3x, the OP193 and the REF193. The entire circuit consumes less than 3 mA from a total budget of 4 mA. The OP193 regulates the output current to satisfy the current summation at the noninverting node of the OP193. A generalized expression for the KCL equation at the OP193's Pin 3 is given by

$$I_{OUT} = \left(\frac{1}{R7}\right) \times \left(\frac{TMP3x \times R3}{R1} + \frac{V_{REF} \times R3}{R2}\right)$$

For each of the three temperature sensors, the table below illustrates the values for each of the components, P1, P2, and R1–R4.

Table 4. Circuit Element Values for Loop Transmitter

Sensor	R1(kΩ)	P1(kΩ)	R2(Ω)	P2(Ω)	R3(kΩ)	R4(kΩ)
TMP35	97.6	5	1.58 M	100 k	140	56.2
TMP36	97.6	5	931 k	50 k	97.6	47
TMP37	97.6	5	10.5 k	500	84.5	8.45

The 4 mA offset trim is provided by P2, and P1 provides the circuit's full-scale gain trim at 20 mA. These two trims do not interact because the noninverting input of the OP193 is held at a virtual ground. The zero-scale and full-scale output currents of the circuit are adjusted according to the operating temperature range of each temperature sensor. The Schottky diode, D1, is required in this circuit to prevent loop supply power-on transients from pulling the noninverting input of the OP193 more than 300 mV below its inverting input. Without this diode, such transients could cause phase reversal of the operational amplifier and possible latch-up of the transmitter. The loop supply voltage compliance of the circuit is limited by the maximum applied input voltage to the REF193; it is from 9 V to 18 V.

# TMP35/TMP36/TMP37

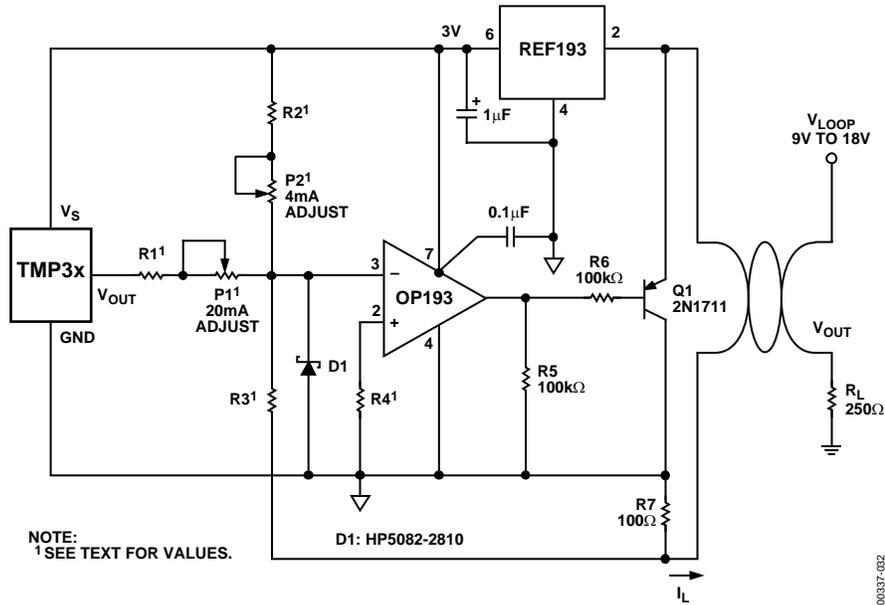


Figure 33. Temperature to 4–20 mA Loop Transmitter

## TEMPERATURE-TO-FREQUENCY CONVERTER

Another common method of transmitting analog information from a remote location is to convert a voltage to an equivalent value in the frequency domain. This is readily done with any of the low cost, monolithic voltage-to-frequency converters (VFCs) available. These VFCs feature a robust, open-collector output transistor for easy interfacing to digital circuitry. The digital signal produced by the VFC is less susceptible to contamination from external noise sources and line voltage drops because the only important information is the frequency of the digital signal. When the conversions between temperature and frequency are done accurately, the temperature data from the sensors can be reliably transmitted.

The circuit in Figure 34 illustrates a method by which the outputs of these temperature sensors can be converted to a frequency using the AD654. The output signal of the AD654 is a square wave that is proportional to the dc input voltage across Pins 4 and 3. The transfer equation of the circuit is given by

$$f_{OUT} = \left( \frac{V_{TPM} - V_{OFFSET}}{10 \times (R_T \times C_T)} \right)$$

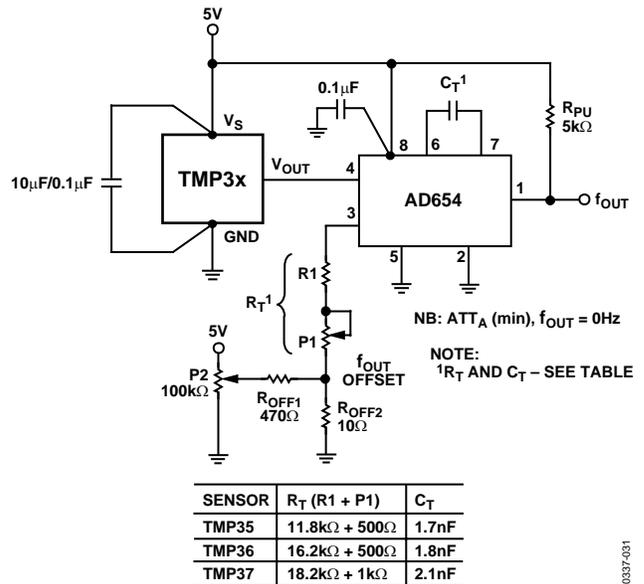


Figure 34. Temperature-to-Frequency Converter

An offset trim network ( $f_{OUT\ OFFSET}$ ) is included with this circuit to set  $f_{OUT}$  at 0 Hz when the temperature sensor's minimum output voltage is reached. Potentiometer P1 is required to calibrate the absolute accuracy of the AD654. The table in Figure 34 illustrates the circuit element values for each of the three sensors. The nominal offset voltage required for 0 Hz output from the TMP35 is 50 mV; for the TMP36 and TMP37, the offset voltage required is 100 mV. For the circuit values shown, the output frequency transfer characteristic of the circuit was set at 50 Hz/°C in all cases. At the receiving end, a frequency-to-voltage converter (FVC) can be used to convert the frequency back to a dc voltage for further processing. One such FVC is the AD650.

For complete information on the AD650 and AD654, consult the individual data sheets for those devices.

## DRIVING LONG CABLES OR HEAVY CAPACITIVE LOADS

Although the TMP3x family of temperature sensors can drive capacitive loads up to 10,000 pF without oscillation, output voltage transient response times can be improved by using a small resistor in series with the output of the temperature sensor, as shown in Figure 35. As an added benefit, this resistor forms a low-pass filter with the cable's capacitance, which helps to reduce bandwidth noise. Since the temperature sensor is likely to be used in environments where the ambient noise level can be very high, this resistor helps to prevent rectification by the devices of the high frequency noise. The combination of this resistor and the supply bypass capacitor offers the best protection.

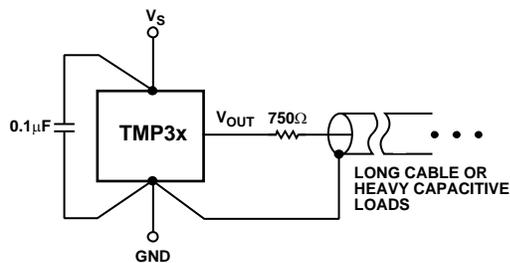


Figure 35. Driving Long Cables or Heavy Capacitive Loads

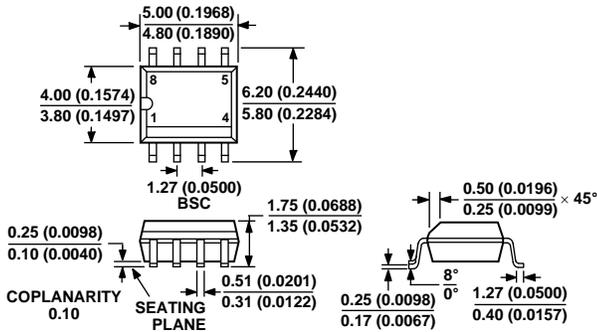
## COMMENTARY ON LONG-TERM STABILITY

The concept of long-term stability has been used for many years to describe by what amount an IC's parameter shifts during its lifetime. This is a concept that has been typically applied to both voltage references and monolithic temperature sensors. Unfortunately, integrated circuits cannot be evaluated at room temperature (25°C) for 10 years or so to determine this shift. As a result, manufacturers very typically perform accelerated lifetime testing of integrated circuits by operating ICs at elevated temperatures (between 125°C and 150°C) over a shorter period of time (typically, between 500 and 1,000 hours).

As a result of this operation, the lifetime of an integrated circuit is significantly accelerated due to the increase in rates of reaction within the semiconductor material.

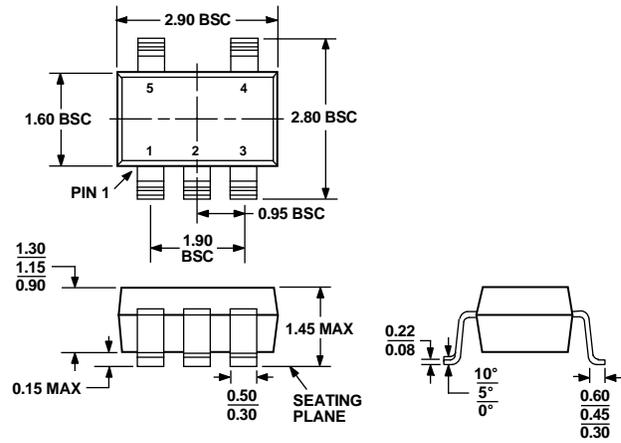
# TMP35/TMP36/TMP37

## OUTLINE DIMENSIONS



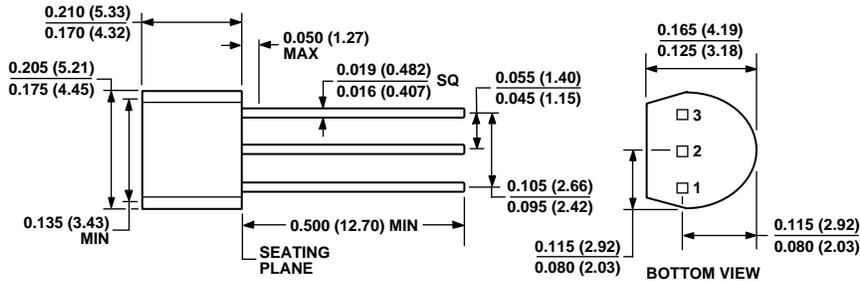
COMPLIANT TO JEDEC STANDARDS MS-012AA  
 CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS  
 (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR  
 REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

Figure 36. 8-Lead Standard Small Outline Package [SOIC]  
 Narrow Body (RN-8)  
 Dimensions shown in millimeters and (inches)



COMPLIANT TO JEDEC STANDARDS MO-178AA

Figure 37. 5-Lead Plastic Surface-Mount Package [SOT-23]  
 (RT-5)  
 Dimensions shown in millimeters



COMPLIANT TO JEDEC STANDARDS TO-226-AA  
 CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS  
 (IN PARENTHESES) ARE ROUNDED-OFF EQUIVALENTS FOR  
 REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 38. 3-Pin Plastic Header-Style Package [TO-92]  
 Dimensions shown in inches and (millimeters)

## ORDERING GUIDE

Model	Accuracy at 25°C (°C max)	Linear Operating Temperature Range	Package Description	Package Option	Branding
TMP35FS	±2.0	10°C to 125°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	T5G
TMP35FS-REEL	±2.0	10°C to 125°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP35GRT-REEL7	±3.0	10°C to 125°C	5-Lead Plastic Surface-Mount Package (SOT-23)	RT-5	
TMP35GS	±3.0	10°C to 125°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP35GS-REEL	±3.0	10°C to 125°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP35GT9	±3.0	10°C to 125°C	3-Pin Plastic Header-Style Package (TO-92)	TO-92	
TMP36FS	±2.0	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	T6G T6G
TMP36FS-REEL	±2.0	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP36FSZ <sup>1</sup>	±2.0	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP36FSZ-REEL <sup>1</sup>	±2.0	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP36GRT-REEL7	±3.0	-40°C to +125°C	5-Lead Plastic Surface-Mount Package (SOT-23)	RT-5	
TMP36GRTZ-REEL7 <sup>1</sup>	±3.0	-40°C to +125°C	5-Lead Plastic Surface-Mount Package (SOT-23)	RT-5	
TMP36GS	±3.0	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP36GS-REEL	±3.0	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP36GS-REEL7	±3.0	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP36GSZ <sup>1</sup>	±3.0	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP36GSZ-REEL <sup>1</sup>	±3.0	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP36GSZ-REEL7 <sup>1</sup>	±3.0	-40°C to +125°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP36GT9	±3.0	-40°C to +125°C	3-Pin Plastic Header-Style Package (TO-92)	TO-92	
TMP36CSURF			DIE		
TMP37FS	±2.0	5°C to 100°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	T7G
TMP37FS-REEL	±2.0	5°C to 100°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP37FT9	±2.0	5°C to 100°C	3-Pin Plastic Header-Style Package (TO-92)	TO-92	
TMP37FT9-REEL	±2.0	5°C to 100°C	3-Pin Plastic Header-Style Package (TO-92)	TO-92	
TMP37GRT-REEL7	±3.0	5°C to 100°C	5-Lead Plastic Surface-Mount Package (SOT-23)	RT-5	
TMP37GS	±3.0	5°C to 100°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP37GS-REEL	±3.0	5°C to 100°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP37GSZ <sup>1</sup>	±3.0	5°C to 100°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP37GSZ-REEL <sup>1</sup>	±3.0	5°C to 100°C	8-Lead Standard Small Outline Package (SOIC)	RN-8	
TMP37GT9	±3.0	5°C to 100°C	3-Pin Plastic Header-Style Package (TO-92)	TO-92	
TMP37GT9-REEL	±3.0	5°C to 100°C	3-Pin Plastic Header-Style Package (TO-92)	TO-3	

<sup>1</sup> Z = Pb-free part.

**NOTES**